

## QIAOXIN N-Channel Super Trench II Power MOSFET

### Description

The series of devices uses **Super Trench II** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of  $R_{DS(on)}$  and  $Q_g$ . This device is ideal for high-frequency switching and synchronous rectification.

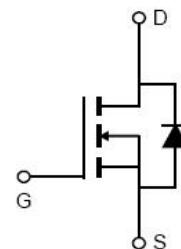
### Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

### General Features

- $V_{DS} = 85V, I_D = 180A$   
 $R_{DS(on)} = 2.9m\Omega$ , typical (TO-220)@  $V_{GS} = 10V$
- Excellent gate charge  $\times R_{DS(on)}$  product(FOM)
- Very low on-resistance  $R_{DS(on)}$
- 175 °C operating temperature
- Pb-free lead plating

TO-220



Schematic Diagram

### Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
VCRR 031N85M	VCRR 031N85M	TO-220	-	-	-

### Absolute Maximum Ratings ( $T_c=25^\circ C$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	$V_{DS}$	85	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Drain Current-Continuous	$I_D$	180	A
Drain Current-Continuous( $T_c=100^\circ C$ )	$I_D(100^\circ C)$	135	A
Pulsed Drain Current	$I_{DM}$	720	A
Maximum Power Dissipation	$P_D$	230	W
Derating factor		1.53	W/°C
Single pulse avalanche energy (Note1)	$E_{AS}$	1344	mJ
Operating Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 To 175	°C

### Thermal Characteristic

Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	0.65	°C/W
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**Electrical Characteristics ( $T_c=25^\circ\text{C}$  unless otherwise noted)**

Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	85		-	V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}}=85\text{V}, V_{\text{GS}}=0\text{V}$	-	-	1	$\mu\text{A}$
Gate-Body Leakage Current	$I_{\text{GSS}}$	$V_{\text{GS}}=\pm20\text{V}, V_{\text{DS}}=0\text{V}$	-	-	$\pm100$	nA
<b>On Characteristics</b>						
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	2.0	3.0	4.0	V
Drain-Source On-State Resistance	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=90\text{A}$	-	2.9	3.1	$\text{m}\Omega$
Forward Transconductance	$g_{\text{fS}}$	$V_{\text{DS}}=5\text{V}, I_{\text{D}}=90\text{A}$		100	-	S
<b>Dynamic Characteristics</b>						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{DS}}=40\text{V}, V_{\text{GS}}=0\text{V}, F=1.0\text{MHz}$	-	7650	-	PF
Output Capacitance	$C_{\text{oss}}$		-	1350	-	PF
Reverse Transfer Capacitance	$C_{\text{rss}}$		-	62	-	PF
<b>Switching Characteristics</b> (Note 2)						
Turn-on Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}}=40\text{V}, I_{\text{D}}=90\text{A}$ $V_{\text{GS}}=10\text{V}, R_{\text{G}}=1.6\Omega$	-	25	-	nS
Turn-on Rise Time	$t_r$		-	15	-	nS
Turn-Off Delay Time	$t_{\text{d}(\text{off})}$		-	52	-	nS
Turn-Off Fall Time	$t_f$		-	16	-	nS
Total Gate Charge	$Q_g$	$V_{\text{DS}}=40\text{V}, I_{\text{D}}=90\text{A}, V_{\text{GS}}=10\text{V}$	-	117	-	nC
Gate-Source Charge	$Q_{\text{gs}}$		-	36	-	nC
Gate-Drain Charge	$Q_{\text{gd}}$		-	31	-	nC
<b>Drain-Source Diode Characteristics</b>						
Diode Forward Voltage	$V_{\text{SD}}$	$V_{\text{GS}}=0\text{V}, I_{\text{S}}=90\text{A}$	-		1.2	V
Diode Forward Current	$I_{\text{S}}$		-	-	180	A
Reverse Recovery Time	$t_{\text{rr}}$	$T_J = 25^\circ\text{C}, I_F = 90\text{A}$ $dI/dt = 100\text{A}/\mu\text{s}$	-	85	-	nS
Reverse Recovery Charge	$Q_{\text{rr}}$		-	156	-	nC

**Notes:**

1. EAS condition :  $T_j=25^\circ\text{C}, V_{\text{DD}}=40\text{V}, V_G=10\text{V}, L=0.5\text{mH}, R_g=25\Omega$
2. Guaranteed by design, not subject to production
3. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink  $k$ , assuming a maximum junction temperature of  $T_J(\text{MAX})=175^\circ\text{C}$ . The SOA curve provides a single pulse rating.

## Typical Electrical and Thermal Characteristics

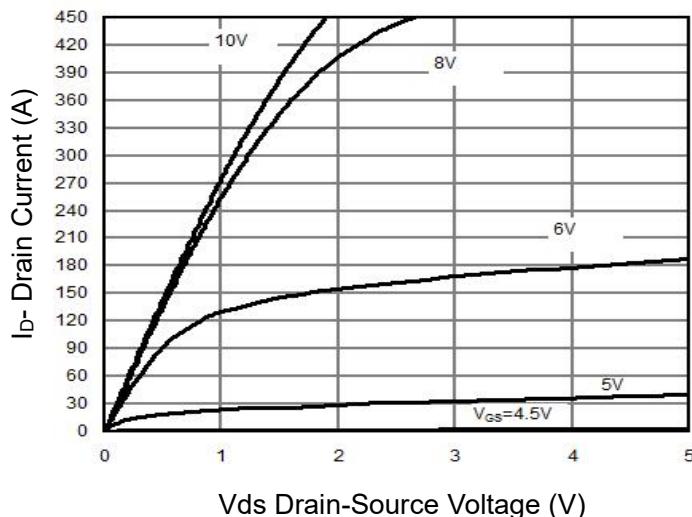


Figure 1 Output Characteristics

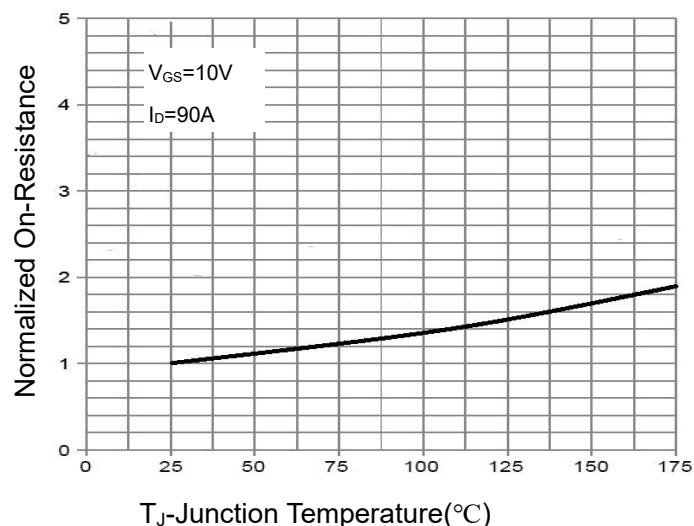


Figure 4 Rdson-Junction Temperature

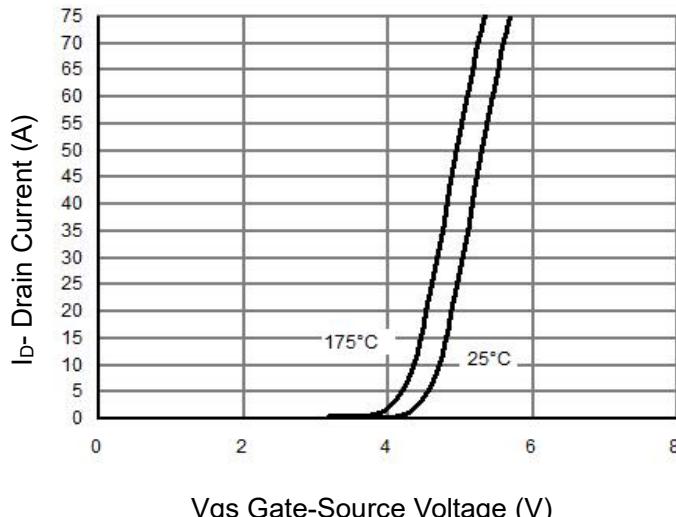


Figure 2 Transfer Characteristics

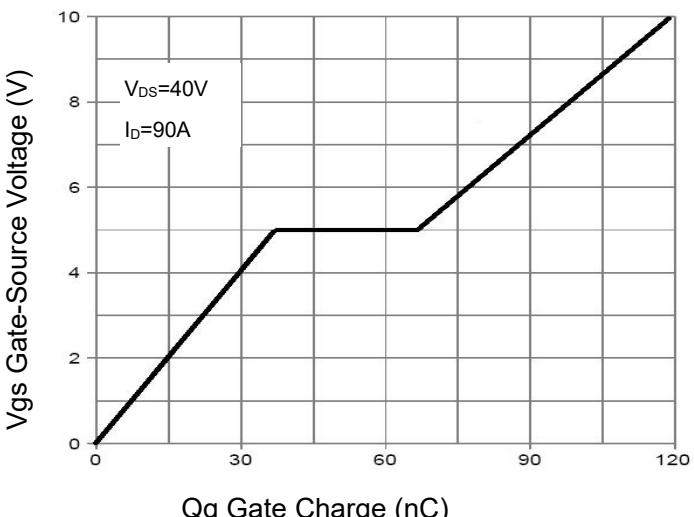


Figure 5 Gate Charge

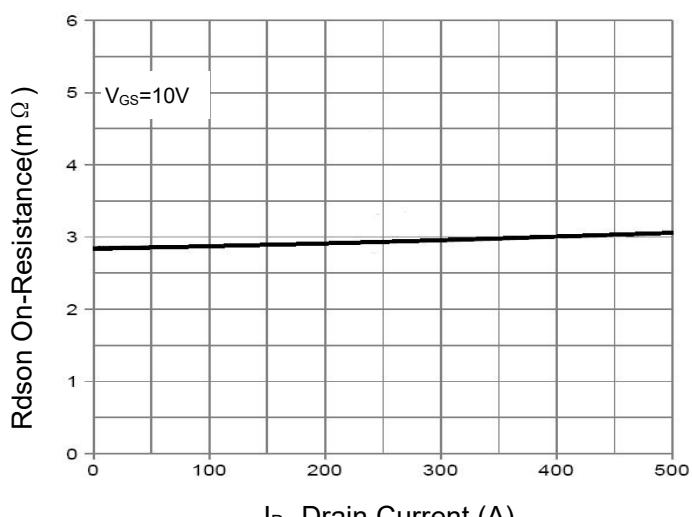


Figure 3 Rdson- Drain Current

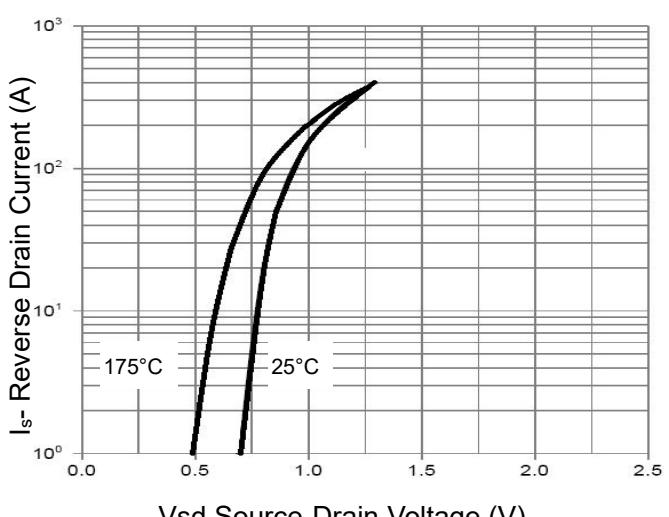
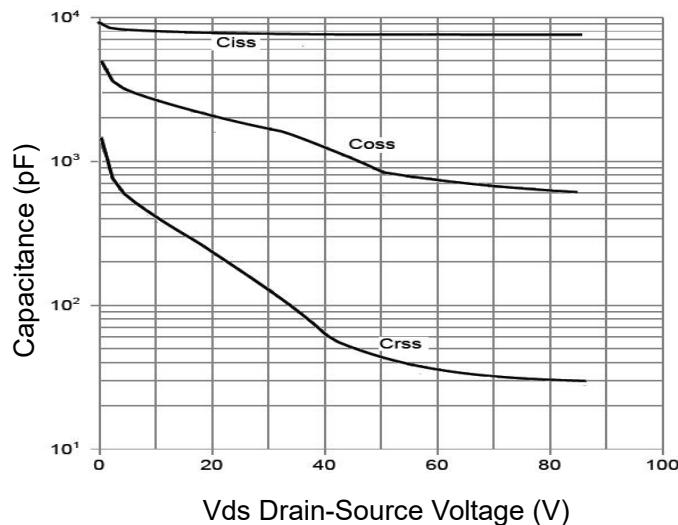
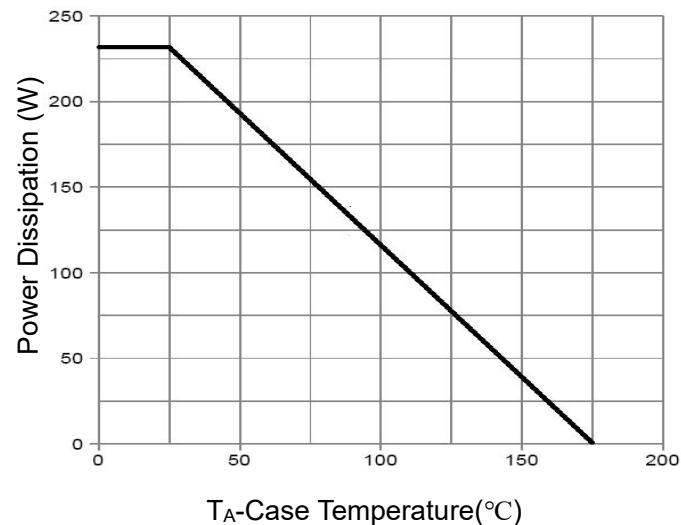


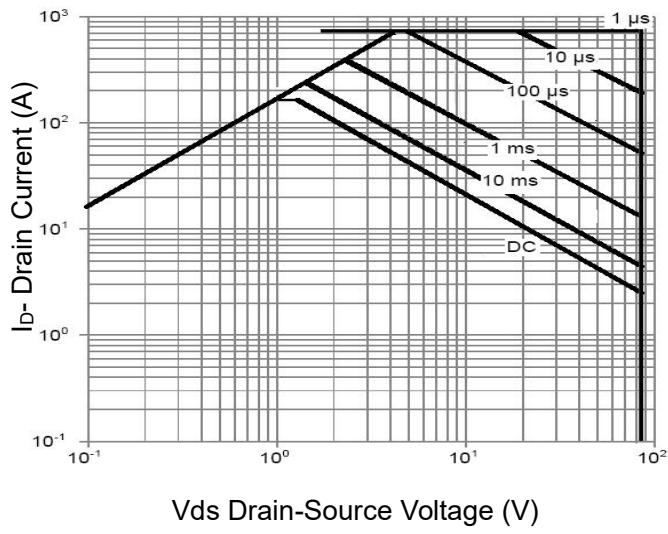
Figure 6 Source- Drain Diode Forward



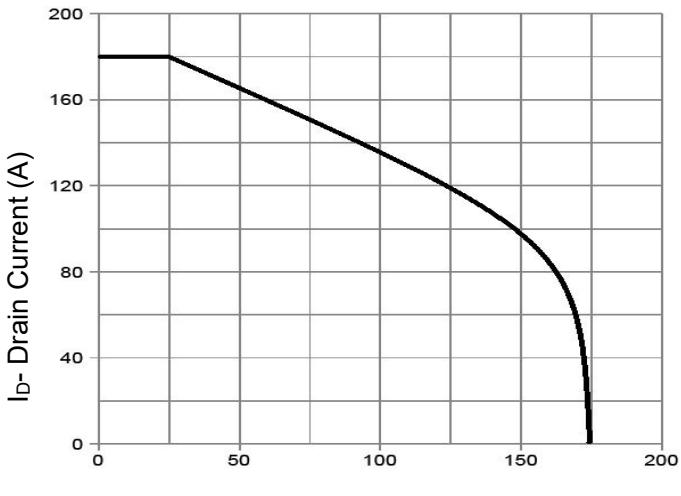
**Figure 7 Capacitance vs Vds**



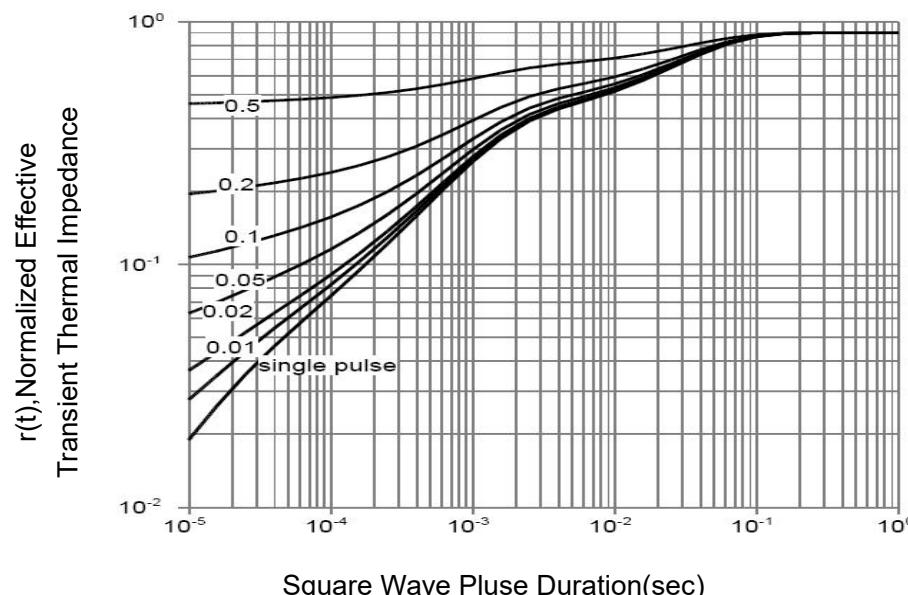
**Figure 9 Power De-rating**



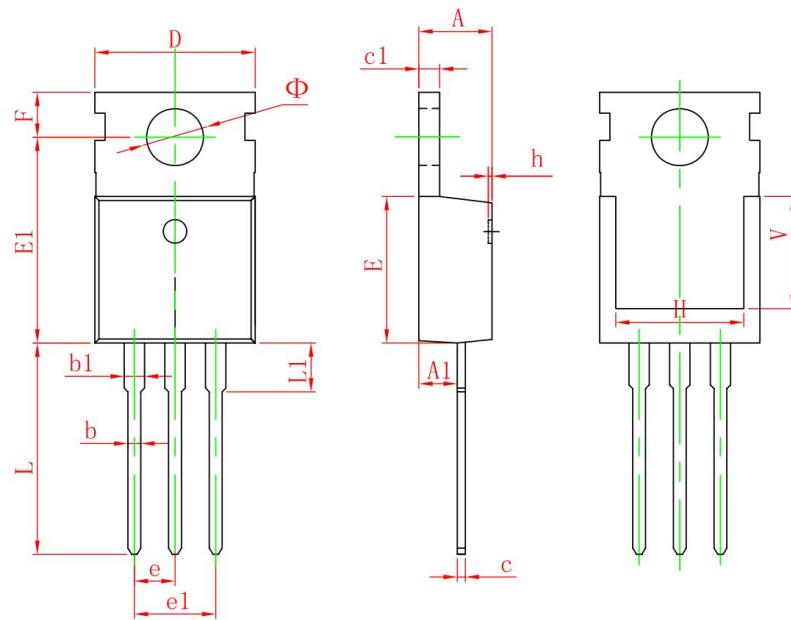
**Figure 8 Safe Operation Area<sup>(Note3)</sup>**



**Figure 10 Current De-rating**



## TO-220-3L Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.400	4.600	0.173	0.181
A1	2.250	2.550	0.089	0.100
b	0.710	0.910	0.028	0.036
b1	1.170	1.370	0.046	0.054
c	0.330	0.650	0.013	0.026
c1	1.200	1.400	0.047	0.055
D	9.910	10.250	0.390	0.404
E	8.950	9.750	0.352	0.384
E1	12.650	13.050	0.498	0.514
e	2.540 TYP.		0.100 TYP.	
e1	4.980	5.180	0.196	0.204
F	2.650	2.950	0.104	0.116
H	7.900	8.100	0.311	0.319
h	0.000	0.300	0.000	0.012
L	12.900	13.400	0.508	0.528
L1	2.850	3.250	0.112	0.128
V	6.900 REF.		0.276 REF.	
Φ	3.400	3.800	0.134	0.150

### **Attention**

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